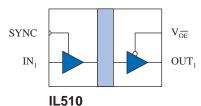
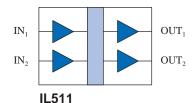
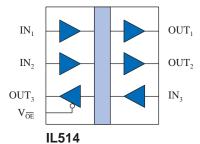


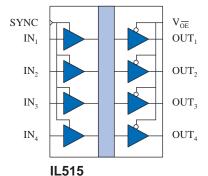
2 Mbps DC-Correct Digital Isolators

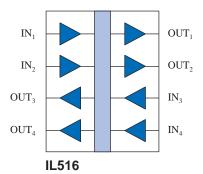
Functional Diagrams











IsoLoop is a registered trademark of NVE Corporation. *U.S. Patent numbers 5,831,426; 6,300,617 and others.

Features

- +5 V / +3.3 V CMOS/TTL Compatible
- 2 Mbps Maximum Speed
- DC-Correct
- External Clocking Option (IL510 and IL515)
- Very Low EMC
- 2500 V_{RMS} Isolation (1 min.)
- 10 ns Pulse Width Distortion
- 25 ns Propagation Delay
- 30 kV/µs Typical Common Mode Rejection
- Low EMC Footprint
- 8-pin MSOP; 0.3" and 0.15" 8-pin and 16-pin SOIC Packages
- UL 1577 and IEC 61010-2001 Approved

Applications

- ADCs and DACs
- · Digital Fieldbus
- RS-485 and RS-422
- Multiplexed Data Transmission
- Data Interfaces
- Board-to-Board Communication
- Hi-Fi Audio
- Digital Noise Reduction
- Ground Loop Elimination
- · Peripheral Interfaces
- Parallel Bus
- Logic Level Shifting

Description

NVE's IL500-Series isolators are CMOS devices manufactured with NVE's patented* IsoLoop® spintronic Giant Magnetoresistive (GMR) technology.

Compared to the industry-standard IL700-Series isolators, which have speeds up to 150 Mbps, IL500-Series isolators are more cost effective, offer a DC-correct design, and have an external clocking option on some models.

All IL500-Series isolator channels operate at 2 Mbps over the full temperature and supply voltage range. The symmetric magnetic coupling barrier provides a propagation delay of 25 ns and a pulse width distortion of 10 ns.

REV. E



Absolute Maximum Ratings

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Storage Temperature	T_{s}	-55		150	°C	
Ambient Operating Temperature ⁽¹⁾	T_A	-55		150	°C	
Supply Voltage	V_{DD1}, V_{DD2}	-0.5		7	V	
Input Voltage	$V_{\rm I}$	-0.5		$V_{\rm DD} + 0.5$	V	
Output Voltage	V_{o}	-0.5		$V_{\rm DD} + 0.5$	V	
Output Current Drive	I_{o}			10	mA	
Lead Solder Temperature				260	°C	10 sec.
ESD			2		kV	HBM

Recommended Operating Conditions

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Ambient Operating Temperature	T_A	-40		85	°C	
Supply Voltage	V_{DD1}, V_{DD2}	3.0		5.5	V	
Logic High Input Voltage	V_{IH}	2.4		$V_{\scriptscriptstyle m DD}$	V	
Logic Low Input Voltage	$V_{\scriptscriptstyle { m IL}}$	0		0.8	V	
Input Signal Rise and Fall Times ⁽¹⁰⁾	t_{IR}, t_{IF}		DC-Correct			

Insulation Specifications

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions
Creepage Distance						
MSOP		3.0			mm	
0.15" SOIC (8-pin or 16-pin)		4.0			mm	
0.3" SOIC		8.1			mm	
Leakage Current			0.2		μΑ	240 V _{RMS} , 60 Hz
Barrier Impedance			>10 ¹⁴ 3		$\Omega \parallel pF$	

Package Characteristics

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Capacitance (Input–Output) ⁽⁵⁾	C_{I-O}		4		pF	f = 1 MHz
Thermal Resistance						
MSOP	$\theta_{ m JC}$		168		°C/W	Thermeseumle et
0.15" 8-pin SOIC	$\theta_{ m JC}$		144		°C/W	Thermocouple at center underside
0.15" 16-pin SOIC	$\theta_{ m JC}$		41		°C/W	of package
0.3" 16-pin SOIC	$\theta_{ m JC}$		28		°C/W	of package
Package Power Dissipation	$P_{\scriptscriptstyle PD}$			150	mW	$f = 1 \text{ MHz}, V_{DD} = 5 \text{ V}$

Safety and Approvals

IEC61010-1

TUV Certificate Numbers: N1502812, N1502812-101

Classification as Reinforced Insulation

		Pollution	Material	Max. Working
Model	Package	Degree	Group	Voltage
IL5xx-1	MSOP	II	III	$150 \mathrm{V}_{\mathrm{RMS}}$
IL5xx-3	8-pin and 16-pin 0.15" SOIC	II	III	$150 \mathrm{V}_{\mathrm{RMS}}$
IL5xx	0.3" SOIC	II	III	$300 V_{RMS}$

UL 1577

Component Recognition Program File Number: E207481

Rated $2500V_{RMS}$ for 1 minute

Soldering Profile

Per JEDEC J-STD-020C, MSL=2



IL510 Pin Connections

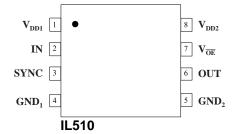
1	V_{DD1}	Supply voltage
2	IN	Data In
3	SYNC	External clock
4	GND_1	Ground return for V _{DD1}
5	GND_2	Ground return for V _{DD2}
6	OUT	Data Out
7	V _{OE}	Output enable (internally held low with $100 \text{ k}\Omega$)
8	V_{DD2}	Supply voltage

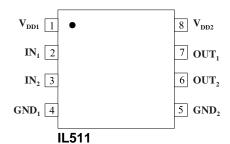
IL511 Pin Connections

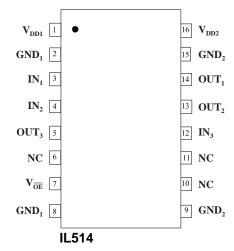
1	V_{DD1}	Supply voltage
2	IN_1	Data in, channel 1
3	IN_2	Data in, channel 2
4	GND_1	Ground return for V _{DD1}
5	GND_2	Ground return for V _{DD2}
6	OUT_2	Data out, channel 2
7	OUT ₁	Data out, channel 1
8	V_{DD2}	Supply voltage

IL514 Pin Connections

1	V_{DD1}	Supply Voltage 1
2	GND ₁	Ground return for V _{DD1}
	OT (D)	(internally connected to pin 8)
3	IN_1	Data in, channel 1
4	IN_2	Data in, channel 2
5	OUT_3	Data out, channel 3
6	NC	No connection
7	V—	Output enable, channel 3
,	$V_{\overline{OE}}$	(internally held low with $100 \text{ k}\Omega$)
8	GND_1	Ground return for V _{DD1}
0	OND	(internally connected to pin 2)
9	GND ₂	Ground return for V _{DD2}
,	OND_2	(internally connected to pin 15)
10	NC	No Connection
11	NC	No Connection
12	IN_3	Data in, channel 3
13	OUT_2	Data out, channel 2
14	OUT_1	Data out, channel 1
15	CND	Ground return for V _{DD2}
15	GND_2	(internally connected to pin 9)
16	V_{DD2}	Supply voltage



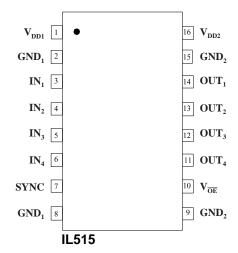






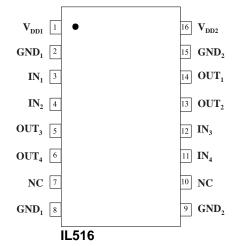
IL515 Pin Connections

1	V_{DD1}	Supply voltage
2	GND_1	Ground return for V _{DD1}
3	IN_1	Data in, channel 1
4	IN_2	Data in, channel 2
5	IN_3	Data in, channel 3
6	IN_4	Data in, channel 4
7	SYNC	External clock
8	GND_1	Ground return for V _{DD1}
9	GND_2	Ground return for V _{DD2}
10	$V_{\overline{OE}}$	Output enable (internally held low with $100 \text{ k}\Omega$)
11	OUT ₄	Data out, channel 4
12	OUT ₃	Data out, channel 3
13	OUT_2	Data out, channel 2
14	OUT ₁	Data out, channel 1
15	GND_2	Ground return for V _{DD2}
16	V_{DD2}	Supply voltage



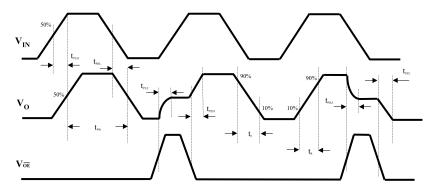
IL516 Pin Connections

1	V_{DD1}	Supply voltage
2	GND_1	Ground Return for V _{DD1}
3	IN_1	Data in, channel 1
4	IN_2	Data in, channel 2
5	OUT ₃	Data out, channel 3
6	OUT_4	Data out, channel 4
7	NC	No connection
8	GND_1	Ground Return for V _{DD1}
9	GND_2	Ground Return for V _{DD2}
10	NC	No connection
11	IN_4	Data in, channel 4
12	IN_3	Data in, channel 3
13	OUT ₂	Data out, channel 2
14	OUT_1	Data out, channel 1
15	GND_2	Ground Return for V _{DD2}
16	V_{DD2}	Supply voltage



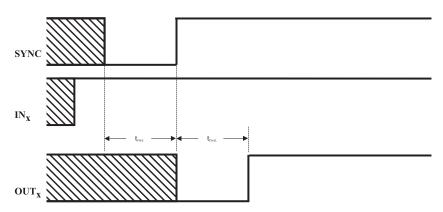


Timing Diagrams



Legend

t_{PLH}	Propagation Delay, Low to High
t_{PHL}	Propagation Delay, High to Low
t_{PW}	Minimum Pulse Width
t_{PLZ}	Propagation Delay, Low to High Impedance
t_{PZH}	Propagation Delay, High Impedance to High
t_{PHZ}	Propagation Delay, High to High Impedance
t_{PZL}	Propagation Delay, High Impedance to Low
t_R	Rise Time
$t_{\rm F}$	Fall Time



Legend

t_{PWS}	SYNC Pulse Width
t_{DVAL}	Time Until Data Valid

Truth Tables

Output Enable

$V_{\rm I}$	$V_{\overline{OE}}$	V_{O}
L	L	L
Н	L	Н
L	Н	Z
Н	Н	Z

SYNC

SYNC	Function
0	Internal Refresh On
1	Internal Refresh Off
_	Input Data Latched to Output

Note: SYNC should be connected to GND to enable internal refresh, $V_{\rm DD}$ to disable internal refresh, or to an external clock. The SYNC pin should not be left unconnected.



3.3 Volt Electrical Specifications

Electrical specifications are T_{min} to T_{max} unless otherwise stated.

Electrical specifications are T_{min} to T_{max} u					T	
Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
		DC Specific	cations			
Input Quiescent Supply Current						<u></u>
IL510, IL511, IL515			15	30	μA	
IL514	I_{DD1}		1.7	2	mA	
IL516			3.3	4	mA	
Output Quiescent Supply Current						
IL510			1.7	2	mA	
IL511, IL514, IL516	I_{DD2}		3.3	4	mA	
IL515			6.6	8	mA	
Logic Input Current	I_{I}	-10		10	μA	
I:- II:-h Output V-lt	V	$V_{DD} - 0.1$	V_{DD}		V	$I_{O} = -20 \mu A, V_{I} = V_{IH}$
Logic High Output Voltage	V_{OH}	0.8 x V _{DD}	0.9 x V _{DD}		V	$I_O = -4 \text{ mA}, V_I = V_{IH}$
	* 7		0	0.1	* 7	$I_{O} = 20 \mu\text{A}, V_{I} = V_{IL}$
Logic Low Output Voltage	V_{OL}		0.5	0.8	V	$I_O = 4 \text{ mA}, V_I = V_{IL}$
		Switching Spec	cifications			/
Maximum Data Rate		2			Mbps	$C_L = 15 \text{ pF}$
	DIV	20			ns	V _o 50% points; SYNC=0
Pulse Width ⁽⁷⁾	PW	25			ns	V ₀ 50% points; SYNC=1
Propagation Delay Input to Output (High to Low)	$t_{ m PHL}$	-		25	ns	$C_L = 15 \text{ pF}$
Propagation Delay Input to Output (Low to High)	$t_{\rm PLH}$			25	ns	$C_L = 15 \text{ pF}$
Propagation Delay Enable to Output	t _{PHZ}			5	ns	$C_L = 15 \text{ pF}$
(High to High Impedance) Propagation Delay Enable to Output	t_{PLZ}			5	ns	$C_L = 15 \text{ pF}$
(Low to High Impedance) Propagation Delay Enable to Output	t _{PZH}			5	ns	$C_L = 15 \text{ pF}$
(High Impedance to High) Propagation Delay Enable to Output				5		$C_L = 15 \text{ pF}$
(High Impedance to Low)	t_{PZL}			3	ns	C _L = 13 pr
Pulse Width Distortion ⁽²⁾	PWD			10	ns	$C_L = 15 \text{ pF}$
Propagation Delay Skew ⁽³⁾	t_{PSK}			10	ns	$C_L = 15 \text{ pF}$
Output Rise Time (10%–90%)	t _R		1	3	ns	$C_L = 15 \text{ pF}$
Output Fall Time (10%–90%)	t_{F}		1	3	ns	$C_L = 15 \text{ pF}$
Common Mode Transient Immunity (Output Logic High or Logic Low) ⁽⁴⁾	CM _H , CM _L	20	30		kV/μs	$V_{CM} = 300 \text{ V}$
Channel-to-Channel Skew	t _{CSK}		3	5	ns	$C_L = 15 \text{ pF}$
SYNC Timing	CSK		3		113	CL = 13 pr
SYNC Time Until Data Valid	+			9	116	
Internal Clock Off Time ⁽¹¹⁾	t _{DVAL}		+	5	μs	
SYNC Pulse Width	t _{OFF}	10		3	ns	
Internal Clock Pulse Width	t _{PWS}	3.5		5	μs	
Dynamic Power Consumption ⁽⁶⁾	t_{PWI}	3.3	140	240	ns μA/MHz	per channel
Dynamic rower Consumption	Magnetic Field	[(8), (x			μΑ/МΠΖ	per channel
Power Frequency Magnetic Immunity				(DD1<3.5 V)	Δ /	50Uz/60Uz
	H_{PF}	1000	1500		A/m	50Hz/60Hz
Pulse Magnetic Field Immunity	H _{PM}	1800	2000		A/m	$t_p = 8\mu s$
Damped Oscillatory Magnetic Field	H _{OSC}	1800	2000		A/m	0.1Hz – 1MHz
Cross-axis Immunity Multiplier (9)	K_X	ļ	2.5			



5 Volt Electrical Specifications

Electrical specifications are T_{min} to T_{max} u						I m . a . m.	
Parameters	Symbol	Min.	Typ.	Max.	Units	Test Conditions	
		DC Specific	cations				
Input Quiescent Supply Current	T	1			T .	T	
IL510, IL511, IL515			24	40	μA		
IL514	I_{DD1}		2	3	mA		
IL516			5	6	mA		
Output Quiescent Supply Current	ı	T	1		•		
IL510			2	3	mA		
IL511, IL514, IL516	I_{DD2}		4	6	mA		
IL515			9	12	mA		
Logic Input Current	$I_{\rm I}$	-10		10	μA		
Logic High Output Voltage	V_{OH}	$V_{DD} - 0.1$	V_{DD}		V	$I_{O} = -20 \mu A, V_{I} = V_{IH}$	
Logic High Output Voltage	▼ OH	$0.8 \times V_{DD}$	$0.9 \times V_{DD}$		•	$I_O = -4 \text{ mA}, V_I = V_{IH}$	
Logic Low Output Voltage	V_{OL}		0	0.1	V	$I_{O} = 20 \mu A, V_{I} = V_{IL}$	
Logic Low Output Voltage	V OL		0.5	0.8	v	$I_O = 4 \text{ mA}, V_I = V_{IL}$	
	\$	Switching Spec	cifications				
Maximum Data Rate		2			Mbps	$C_L = 15 \text{ pF}$	
Pulse Width ⁽⁷⁾	PW	20			ns	V _o 50% points; SYNC=0	
ruise widin	r vv	25			ns	V _o 50% points; SYNC=1	
Propagation Delay Input to Output	tour			25	ns	$C_L = 15 \text{ pF}$	
(High to Low)	$t_{ m PHL}$			23	113	C _L = 15 pr	
Propagation Delay Input to Output	torre			25	ns	$C_L = 15 \text{ pF}$	
(Low to High)	$t_{\rm PLH}$			23	115	CL = 13 pr	
Propagation Delay Enable to Output	tova			5	ns	$C_L = 15 \text{ pF}$	
(High to High Impedance)	$t_{ m PHZ}$			3	113	CL = 13 pr	
Propagation Delay Enable to Output	$t_{\rm PLZ}$			5	ns	$C_L = 15 \text{ pF}$	
(Low to High Impedance)	^t PLZ			9	113	CL = 13 pr	
Propagation Delay Enable to Output	t _{PZH}			5	ns	$C_L = 15 \text{ pF}$	
(High Impedance to High)	TZH				115	OL 10 PI	
Propagation Delay Enable to Output	t_{PZL}			5	ns	$C_L = 15 \text{ pF}$	
(High Impedance to Low)	CPZL			3	113	OL - 13 pr	
Pulse Width Distortion ⁽²⁾	PWD			10	ns	$C_L = 15 \text{ pF}$	
Propagation Delay Skew ⁽³⁾	t_{PSK}			10	ns	$C_L = 15 \text{ pF}$	
Output Rise Time (10%–90%)	t_{R}		1	3	ns	$C_L = 15 \text{ pF}$	
Output Fall Time (10%–90%)	t_{F}		1	3	ns	$C_L = 15 \text{ pF}$	
Common Mode Transient Immunity	$ CM_H , CM_L $	20	30		kV/μs	$V_{cm} = 300 \text{ V}$	
(Output Logic High or Logic Low) (4)	CIVIH , CIVIL	20	30		κ ν/μδ	V cm = 300 V	
Channel-to-Channel Skew	t_{CSK}		3	5	ns	$C_L = 15 \text{ pF}$	
SYNC Timing							
SYNC Time Until Data Valid	$t_{ m DVAL}$			9	μs		
Internal Clock Off Time ⁽¹¹⁾	t _{OFF}			5	ns		
SYNC Pulse Width	t_{PWS}	10			μs		
Internal Clock Pulse Width	t_{PWI}	3.5		5	ns		
Dynamic Power Consumption ⁽⁶⁾			200	340	μA/MHz	per channel	
Magnetic Field Immunity ⁽⁸⁾ (V _{DD2} = 5V, 3V <v<sub>DD1<5.5V)</v<sub>							
Power Frequency Magnetic Immunity	H_{PF}	2800	3500		A/m	50Hz/60Hz	
Pulse Magnetic Field Immunity	H _{PM}	4000	4500		A/m	$t_p = 8 \mu s$	
Damped Oscillatory Magnetic Field	H _{OSC}	4000	4500		A/m	0.1Hz – 1MHz	
Cross-axis Immunity Multiplier ⁽⁹⁾	K _X		2.5				



Notes (apply to both 3.3 V and 5 V specifications):

- 1. Absolute maximum ambient operating temperature means the device will not be damaged if operated under these conditions. It does not guarantee performance.
- 2. PWD is defined as $|t_{PHL} t_{PLH}|$. %PWD is equal to PWD divided by pulse width.
- 3. t_{PSK} is the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} between devices at 25°C.
- 4. CM_H is the maximum common mode voltage slew rate that can be sustained while maintaining $V_O > 0.8 \ V_{DD2}$. CM_L is the maximum common mode input voltage that can be sustained while maintaining $V_O < 0.8 \ V$. The common mode voltage slew rates apply to both rising and falling common mode voltage edges.
- 5. Device is considered a two terminal device: pins on each side of the package are shorted.
- 6. Dynamic power consumption is calculated per channel and is supplied by the channel's input side power supply.
- 7. Minimum pulse width is the minimum value at which specified PWD is guaranteed.
- 8. The relevant test and measurement methods are given in the Electromagnetic Compatibility section on p. 9.
- 9. External magnetic field immunity is improved by this factor if the field direction is "end-to-end" rather than to "pin-to-pin" (see diagram on p. 9).
- If internal clock is used, devices will respond to DC states on inputs within a maximum of 9 μs. Outputs may oscillate if SYNC input slew rate
 is less than 1 V/ms.
- 11. t_{off} is the maximum time for the internal clock to shut down.



Application Information

Electrostatic Discharge Sensitivity

This product has been tested for electrostatic sensitivity to the limits stated in the specifications. However, NVE recommends that all integrated circuits be handled with appropriate care to avoid damage. Damage caused by inappropriate handling or storage could range from performance degradation to complete failure.

Electromagnetic Compatibility

IsoLoop Isolators have the lowest EMC footprint of any isolation technology. IsoLoop Isolators' Wheatstone bridge configuration and differential magnetic field signaling ensure excellent EMC performance against all relevant standards.

Additionally, on the IL510 and IL515, the internal clock can be disabled for even better EMC performance.

These isolators are fully compliant with generic EMC standards EN50081, EN50082-1 and the umbrella line-voltage standard for Information Technology Equipment (ITE) EN61000. NVE has completed compliance tests in the categories below:

EN50081-1

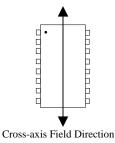
Residential, Commercial & Light Industrial Methods EN55022. EN55014

EN50082-2: Industrial Environment

Methods EN61000-4-2 (ESD), EN61000-4-3 (Electromagnetic Field Immunity), EN61000-4-4 (Electrical Transient Immunity), EN61000-4-6 (RFI Immunity), EN61000-4-8 (Power Frequency Magnetic Field Immunity), EN61000-4-9 (Pulsed Magnetic Field), EN61000-4-10 (Damped Oscillatory Magnetic Field) ENV50204

Radiated Field from Digital Telephones (Immunity Test)

Immunity to external magnetic fields is even higher if the field direction is "end-to-end" rather than to "pin-to-pin" as shown in the diagram below:



Dynamic Power Consumption

IsoLoop Isolators achieve their low power consumption from the way they transmit data across the isolation barrier. A magnetic field is created around the GMR Wheatstone bridge by detecting the edge transitions of the input logic signal and converting them to narrow current pulses. Depending on the direction of the magnetic field, the bridge causes the output comparator to switch following the input logic signal. Since the current pulses are narrow, about 2.5 ns, the power consumption is independent of mark-to-space ratio and solely dependent on frequency. This has obvious advantages over optocouplers, which have power consumption heavily dependent on mark-to-space ratio.

Power Supply Decoupling

Both power supplies to these devices should be decoupled with low ESR ceramic capacitors of at least 47 nF. Capacitors must be located as close as possible to the $V_{\rm DD}$ pins.

DC Correctness, EMC, and the SYNC Function

NVE digital isolators have the lowest EMC noise signature of any high-speed digital isolator on the market today because of the dc nature of the GMR sensors used. It is perhaps fair to include optocouplers in that dc category too, but their limited parametric performance, physically large size, and wear-out problems effectively limit side by side comparisons between NVE's isolators and isolators coupled with RF, matched capacitors, or transformers.

The IL500-Series marks a departure from other NVE coupler families with the inclusion of a patented, controllable refresh clock. The clock ensures that outputs will be synchronized to inputs within 9 µs of the supply voltage passing the CMOS circuit's 1.5 V V_T threshold. Alternatively, on certain models the user can supply an external synchronization clock. There are several advantages to this form of control, the most important being that at power up the user no longer needs to design a synchronization circuit or add firmware to ensure the output is at the same logic level as the input. Unlike other technologies, however, the clock is not required for normal operation and can be gated off to reduce the EMC signature of the end product. This has many advantages in noise-critical applications such as hi-fi audio, motor control, and power conversion. It also allows the use of standard Power on Reset (POR) circuits, common in microcontroller applications, as the means of ensuring the output of the device is in the same state as the input a short time after power up. Figure 1 shows a practical Power on Reset circuit. Decoupling capacitors are omitted for clarity.

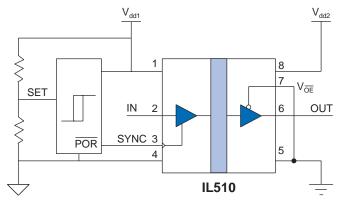


Fig. 1. Typical Power On Reset Circuit for IL510

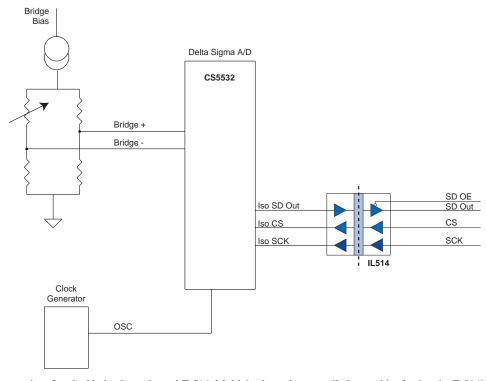
If multiple devices are used on a board and the designer wants to use the refresh clock in continuous mode, the external clock signal can be provided to each IL5xx Isolator, without the beat-frequency noise problems inherent with competing isolator technologies.

The IL510 and IL515 have the SYNC function available to the user. The IL511, IL514, and IL516 are available in continuous clocking mode only (the user cannot turn off the refresh clock on those devices).



Illustrative Applications

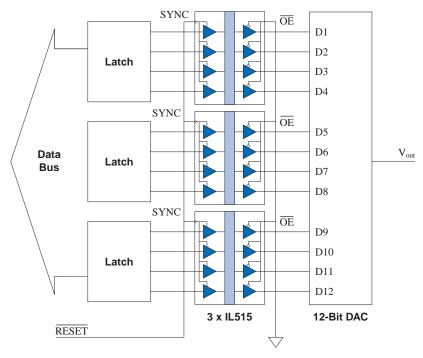
Isolated A/D Converter



A delta-sigma A-D converter interfaced with the three-channel IL514. Multiple channels can easily be combined using the IL514's output enable function.

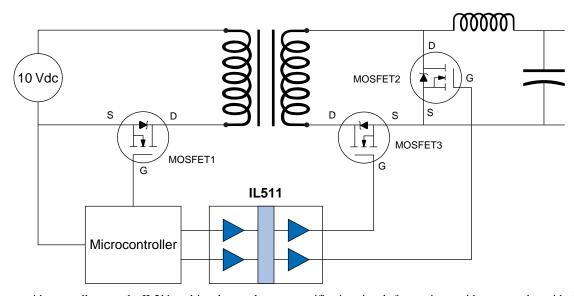


12-Bit D/A Converter Isolation



The IL515 four-channel isolator is ideally suited for parallel bus isolation. The circuit above uses three IL515s to isolate a 12-bit DAC. The unique SYNC function allows the internal clock to be shut off, eliminating the small amount of noise associated with this clock. A reset pulse is applied at power-on to ensure correct data on the isolator outputs. After the reset pulse goes high, data transfer from input to output is initiated by the leading edge of each changing data bit.

Intelligent DC-DC Converter With Synchronous Rectification

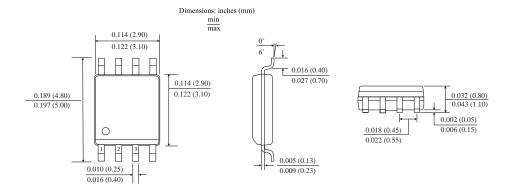


A typical primary-side controller uses the IL511 to drive the synchronous rectification signals from primary side to secondary side. IL511 pulsewidth distortion of 10 ns minimizes MOSFET dead time and maximizes efficiency. The ultra-small MSOP package minimizes board area.

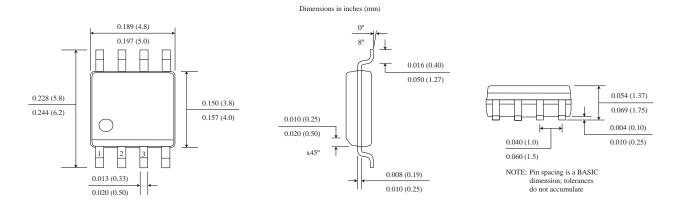


Package Drawings, Dimensions, and Specifications

8-pin MSOP

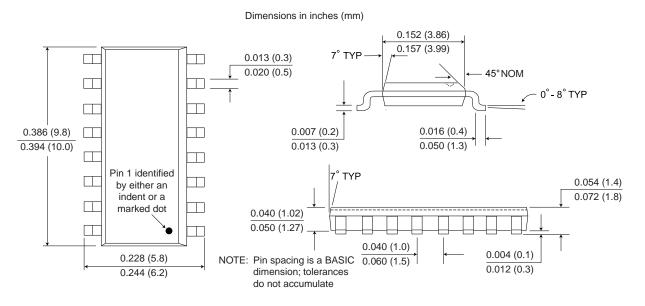


8-pin SOIC Package

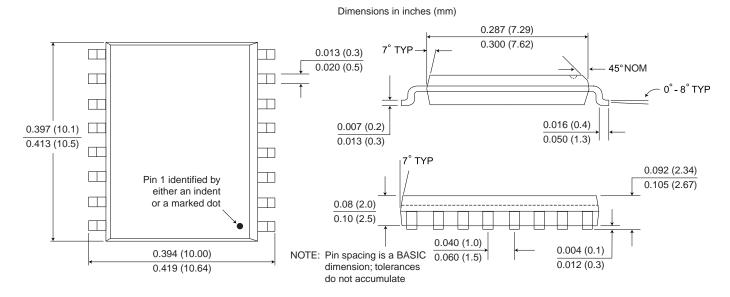




16-pin 0.15" SOIC Package

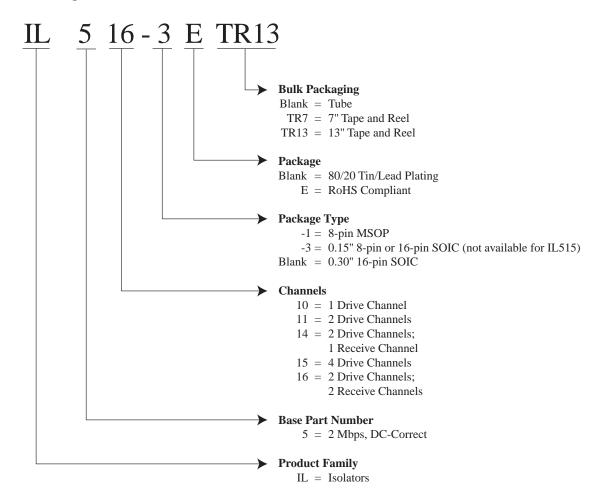


16-pin 0.3" SOIC Package





Ordering Information



RoHS COMPLIANT



ISB-DS-001-IL500-E January 2009 Changes:

Added EMC details.

ISB-DS-001-IL500-D

Changes:

• Add Output Enable to IL515.

• IEC 61010-2001 Approval (removed "pending").

• Added 12-bit DAC illustrative application.

ISB-DS-001-IL500-C

Production release

ISB-DS-001-IL500-B

Initial release

July 2008

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ISB-DS-001-IL500-A June 2008 **Preliminary release**

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About NVE

An ISO 9001 Certified Company

NVE Corporation is a high technology components manufacturer having the unique capability to combine spintronic Giant Magnetoresistive (GMR) materials with integrated circuits to make high performance electronic components. Products include Magnetic Field Sensors, Magnetic Field Gradient Sensors (Gradiometer), Digital Magnetic Field Sensors, Digital Signal Isolators and Isolated Bus Transceivers.

NVE is a leader in GMR research and in 1994 introduced the world's first products using GMR material, a line of GMR magnetic field sensors that can be used for position, magnetic media, wheel speed and current sensing.

NVE is located in Eden Prairie, Minnesota, a suburb of Minneapolis. Please visit our Web site at www.nve.com or call (952) 829-9217 for information on products, sales or distribution.

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Specifications shown are subject to change without notice.

ISB-DS-001-IL500-E January 2009